SCOPE:

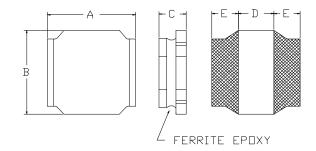
This specification applies to the Pb Free high current type SMD inductors for MNR-3012-SERIES

PRODUCT INDENTIFICATION

<u>MNR</u> - <u>3012</u> - <u>3R3</u> <u>N</u>

- 1 (2
- 3 4
- ① Product Code
- 2 Dimensions Code
- ③ Inductance Code
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 3.0±0.1 mm
B: 3.0±0.1 mm
C: 1.20Max. mm
D: 1.30Typ. mm
E: 0.85Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)
SRF: HP 4291B IMPEDANCE ANALYZER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60°C Max.
- (3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent	L Test	SRF(MHz)	Resistance	Rated DC Current	
PT/NO.	L(µH)	Tolerance	Frequency	Min.	RDC(Ω)±20%	IDC1(A)	IDC2(A)
MNR-3012-1R0□	1.0	N	100KHz/0.25V	110	50m	1.50	1.49
MNR-3012-1R5	1.5	N	100KHz/0.25V	92	60m	1.36	1.40
MNR-3012-2R2	2.2	M,N	100KHz/0.25V	70	80m	1.10	1.20
MNR-3012-3R3	3.3	M,N	100KHz/0.25V	55	0.10	0.91	1.05
MNR-3012-4R7□	4.7	M,N	100KHz/0.25V	48	0.13	0.77	0.98
MNR-3012-6R8	6.8	M,N	100KHz/0.25V	40	0.19	0.60	0.74
MNR-3012-100□	10	M,N	100KHz/0.25V	32	0.29	0.54	0.63
MNR-3012-150	15	M,N	100KHz/0.25V	27	0.45	0.44	0.485
MNR-3012-330	33	M,N	100KHz/0.25V	19	1.03	0.31	0.33
MNR-3012-470	47	M,N	100KHz/0.25V	17	1.45	0.25	0.28

[※] ☐ specify the inductance tolerance,M(±20%),N(±30%)

※ IDC1: Based on inductance change (△L/Lo: drop 30% Max.) @ ambient temp. 25°C

IDC2 : Based on temperature rise ($\triangle T$: 40°C Typ.) Rated DC Current : The less value whith is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		in figure 1 and a load applied unitil the figure in the arrow		
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
	no mechanical	PCB dimension shall the page 7/9		
	damage or elec-	F(Pressurization)		
	trical damege.			
		R5 45±2 45±2 10 20 R340		
		PRESSURE ROD figure-1		
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		and when a vibration having an amplitude of 1.52mm		
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should		
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.		
	damage.	(A total of 6 hours)		
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated		
	More than 90%	over the whole of the sample before hard, the sample shall		
		then be preheated for about 2 minutes in a temperature of		
		130~150°C and after it has been immersed to a depth 0.5mm		
		below for 3±0.2 seconds fully in molten solder M705 with		
		a temperature of 245±5℃.		
		More than 90% of the electrode sections shall be couered		
		with new solder smoothly when the sample is taken out of		
		the solder bath.		

MECHANICAL

TEST ITEM	SPECIFICATION			
TEST ITEM Resistance to Soldering heat reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering 300 250 Reak temperature 260±3 © 10 sec 150 - 180 © 2 min 100 100 100 100 100 100 100 1		

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\!$
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM			SPECIFICATION				
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperatu	a temperature of 85±2℃ and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal					
	damage.	humidity fo	r 1 hour.				
	A 1 / / - (150/	Th	-h-II h - l-f(f 00 4 h				
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a temperature of -25±3°C.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical		after the sample has been left in a normal temperature and				
	damage.		normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the table	in the table 2 below and then it shall be subjected to standard				
	There shall be	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be made.					
	ge of problems						
		table 2					
			Temperature	Duration			
		1	−25±3 °C	30 min.			
			(Themostat No.1)				
		2	Standard	No.4 - No.2			
		-	atmospheric	No.1→No.2			
		3	85±2℃	30 min.			
			(Themostat No.2)	Jo IIIII.			
		4	Standard				
		4	atmospheric	No.2→No.1			
Majatura ataraga	A L // a < +E9/	The comple	aball ha laft for OC+4 have	so in a tamparatura of			
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of					
		40±2℃ and a humidity(RH) of 90~95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
	damage.	normal humidity more than 1 hour.					

The sample shall be reflow soldered onto the printed circuit board in every test.

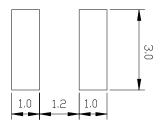


(5) LAND DIMENSION (Ref.)

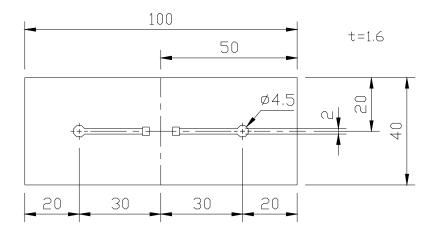
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm



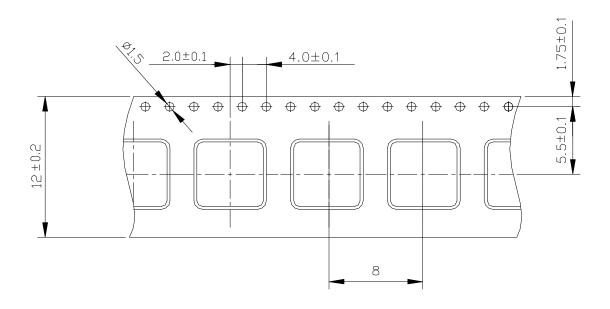
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



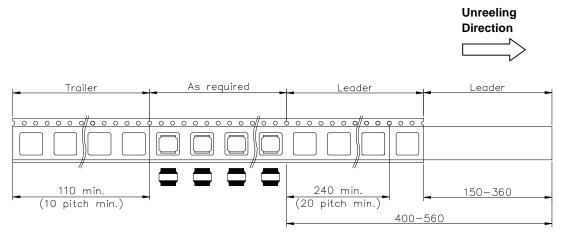


(6) PACKAGING

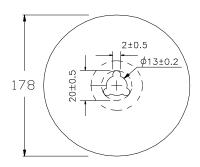
(6)-1 CARRIER TAPE DIMENSIONS (mm)

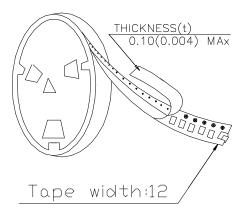


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1500pcs/Reel

The products are packaged so that no damage will be sustained.